

PMP21065A REV A Bill of Materials

Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	C1, C11, C12, C13, C19, C20, C24, C25, C28, C30, C31, C37, C38, C40, C41, C50, C53, C54, C55, C61, C67, C68, C69	23	0.1uF	0402YC104KAT2A	AVX	CAP, CERM, 0.1 µF, 16 V, +/- 10%, X7R, 0402	0402
2	C2, C3, C7, C29, C39	5	10uF	GRM155R61A106ME21D	MuRata	CAP, CERM, 10 µF, 10 V, +/- 20%, X5R, 0402	0402
3	C5, C6, C15, C16, C22, C23, C33, C34, C43, C44, C46, C47, C57, C58, C63, C64	16	22uF	GRM187R61A226ME15D	MuRata	CAP, CERM, 22 µF, 10 V, +/- 20%, X5R, 0603	0603
4	C8	1	0.22uF	GRM155R61A224KE19D	MuRata	CAP, CERM, 0.22 µF, 10 V, +/- 10%, X5R, 0402	0402
5	C9, C10, C17, C18, C26, C27, C35, C36, C48, C49, C51, C52, C59, C60, C65, C66	16	10uF	EMK107BBJ106MA-T	Taiyo Yuden	CAP, CERM, 10 µF, 16 V, +/- 20%, X5R, 0603	0603
6	J1	1		ED555/2DS	On-Shore Technology	Terminal Block, 3.5mm Pitch, 2x1, TH	7.0x8.2x6.5mm
7	J2	1		HTSW-103-07-G-S	Samtec	Header, 100mil, 3x1, Gold, TH	Header, 100mil, 3x1, TH
8	L1, L5, L7	3	2.2uH	PA4332.222NLT	Pulse Engineering	Inductor, Wirewound, Powdered Iron, 2.2 µH, 4.3 A, 0.048 ohm, SMD	4.2x4.2x2.0mm
9	L2, L3, L6, L8	4				Inductor, Shielded, Ferrite, 3.3 µH, 2.4 A, 0.0516 ohm, SMD	
10	L4	1				Inductor, Shielded, 3.3 µH, 3.3 A, 0.087 ohm, SMD	
11	R1, R6, R10, R20, R24, R25, R27, R28, R35, R37	10	10k	CRCW040210K0JNED	Vishay-Dale	RES, 10 k, 5%, 0.063 W, 0402	0402
12	R2, R12, R17, R43, R45	5	0	CRCW04020000Z0ED	Vishay-Dale	RES, 0, 5%, 0.063 W, 0402	0402
13	R3	1	5.76k	CRCW04025K76FKED	Vishay-Dale	RES, 5.76 k, 1%, 0.063 W, 0402	0402
14	R5, R9, R14, R23, R32, R34, R39, R42	8	10.0k	CRCW040210K0FKED	Vishay-Dale	RES, 10.0 k, 1%, 0.063 W, 0402	0402
15	R7	1	22.6k	CRCW040222K6FKED	Vishay-Dale	RES, 22.6 k, 1%, 0.063 W, 0402	0402
16	R11, R30, R40	3	33.2k	CRCW040233K2FKED	Vishay-Dale	RES, 33.2 k, 1%, 0.063 W, 0402	0402
17	R16	1	100k	CRCW0402100KFKED	Vishay-Dale	RES, 100 k, 1%, 0.063 W, 0402	0402
18	R18	1	500	PNM0402E5000BST1	Vishay Thin Film	RES, 500, 0.1%, 0.05 W, 0402	0402
19	R21	1	54.9k	CRCW040254K9FKED	Vishay-Dale	RES, 54.9 k, 1%, 0.063 W, 0402	0402
20	R29, R36	2	2.49k	CRCW04022K49FKED	Vishay-Dale	RES, 2.49 k, 1%, 0.063 W, 0402	0402
21	TP1, TP2, TP5, TP7, TP8, TP11, TP12, TP13, TP15, TP19, TP20, TP23, TP24, TP27	14		5010	Keystone	Test Point, Multipurpose, Red, TH	Red Multipurpose Testpoint
22	TP3, TP4, TP6, TP9, TP10, TP14, TP16, TP17, TP18, TP21, TP22, TP25, TP26, TP28	14		5011	Keystone	Test Point, Multipurpose, Black, TH	Black Multipurpose Testpoint
23	U1, U3, U4, U10	4		TPS562201DDCR	Texas Instruments	4.5V to 17V Input, 2A Output, Synchronous Step-Down Converter, DDC0006A (SOT-23-T-6)	DDC0006A
24	U2	1		TPS51206DSQR	Texas Instruments	Single Output LDO, 2 A, with VTREF Buffered Reference for DDR2, DDR3, DDR3L, 10-pin SON (DSQ), -40 to 85 degC, Green (RoHS & no Sb/Br)	DSQ0010A
25	U5	1		TLV71318PDQNR	Texas Instruments	Capacitor-Free, 150-mA, Low-Dropout Regulator With Foldback Current Limit for Portable Devices, DQN0004A (X2SON-4)	DQN0004A
26	U6	1		TPS22945DCKR	Texas Instruments	5.5V, 0.2A, 500mΩ, 100mA Current Limit Load Switch, DCK0005A (SOT-SC70-5)	DCK0005A
27	U7	1		TPS563201DDC/T	Texas Instruments	4.5V to 16 V Input, 3-A Synchronous Step-Down Voltage Regulator, DDC0006A (SOT-23-T-6)	DDC0006A
28	U8	1		TPS2065DDBVR	Texas Instruments	Current-Limited, Power-Distribution Switches, DBV0005A (SOT-23-5)	DBV0005A
29	U9, U11	2		TPS564201DDCR	Texas Instruments	4.5V to 17V Input, 4A Output, Synchronous Step-Down Converter, DDC0006A (SOT-23-T-6)	DDC0006A
30	U12	1		TPS561208DDCR	Texas Instruments	4.5-V to 17-V Input, 2-A Synchronous Step-Down Voltage Regulator, DDC0006A (SOT-23-T-6)	DDC0006A
31	U13	1		TLV71310PDQNR	Texas Instruments	Capacitor-Free, 150-mA, Low-Dropout Regulator With Foldback Current Limit for Portable Devices, DQN0004A (X2SON-4)	DQN0004A
32	C4, C14, C21, C32, C42, C45, C56, C62	0	0.1uF	0402YC104KAT2A	AVX	CAP, CERM, 0.1 µF, 16 V, +/- 10%, X7R, 0402	0402
33	R4, R8, R13, R15, R19, R22, R26, R31, R33, R38, R41, R44	0	0	CRCW04020000Z0ED	Vishay-Dale	RES, 0, 5%, 0.063 W, 0402	0402

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